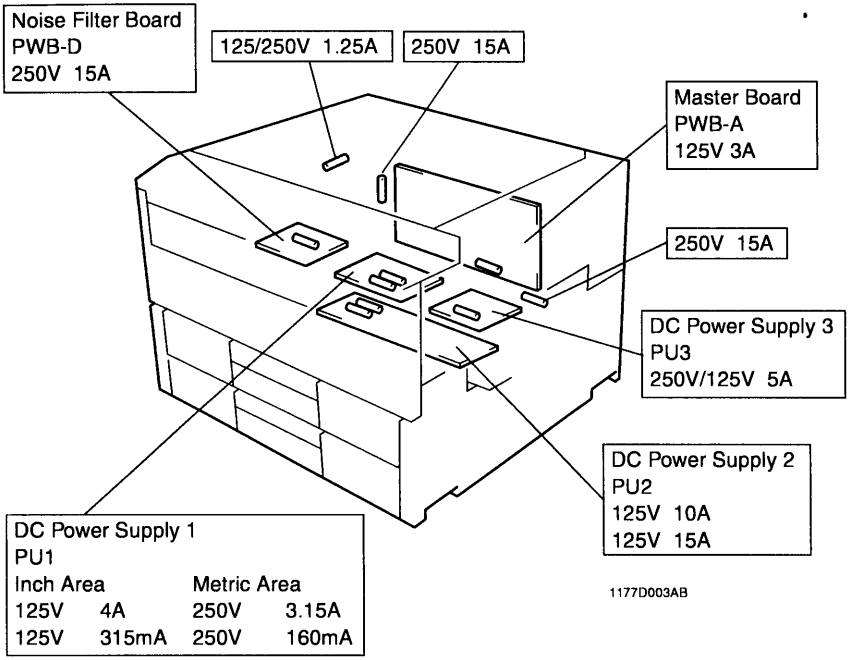
1-3. IDENTIFICATION OF FUSES



1-4. PRECAUTIONS FOR HANDLING THE LASER EQUIPMENT

- The laser used in this copier is a semiconductor laser having the following specifications.

Max. power: 5mW
Output wavelength: 770~795nm

- When laser protective goggles are to be used, select ones with a lens conforming to the above specifications.
- When a disassembly job needs to be performed in the laser beam path, such as when working around the printerhead and PC Drum, be sure first to turn the copier OFF.
- If the job requires that the copier be left ON, take off your watch and ring and wear laser protective goggles.
- A highly reflective tool can be dangerous if it is brought into the laser beam path. Use utmost care when handling tools on the user's premises.
- The printerhead is notmaintainable in the field. It is to be replaced as an assembly including the control board. Never, therefore, attempt to remove the laser diode or adjust trimmers on the control board.